



Features

- Ideal for surface mount applications
- Easy pick and place
- Built-in strain relief
- Low forward voltage drop



SMB



Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
ES3DB-13-F	SMB	ES3A-ES3J	3000

Maximum Ratings (Ta=25°C unless otherwise noted)

Single phase half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Type Number	ES3A	ES3B	ES3C	ES3D	ES3E	ES3G	ES3J	Units
Maximum Recurrent Peak Reverse Voltage	50	100	150	200	300	400	600	V
Maximum RMS Voltage	35	70	105	140	210	280	420	V
Maximum DC Blocking Voltage	50	100	150	200	300	400	600	V
Maximum Average Forward Rectified Current .375"(9.5mm) Lead Length at Ta=55°C	3.0							A
Peak Forward Surge Current, 8.3 ms single half sine-wave superimposed on rated load (JEDEC method)	80							A
Maximum Instantaneous Forward Voltage at 2.0A	1.0				1.4		1.7	V
Maximum DC Reverse Current Ta=25°C	5.0							uA
at Rated DC Blocking Voltage Ta=100°C	50							uA
Maximum Reverse Recovery Time (Note 1)	35							nS
Typical Junction Capacitance (Note 2)	60							pF
Operating and Storage Temperature Range Tj, Tstg	-65 — +150							°C

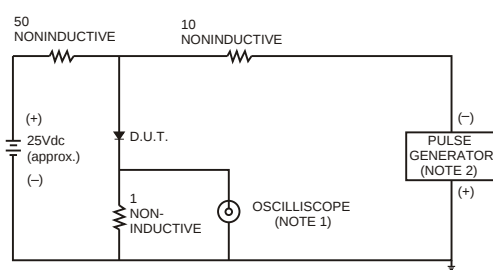
NOTES:

1. Reverse Recovery Time test condition: IF=0.5A, IR=1.0A, IRR=0.25A
2. Measured at 1MHz and applied reverse voltage of 4.0V D.C.



Typical Characteristics

FIG.1- TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTIC



NOTES: 1. Rise Time= 7ns max., Input Impedance= 1 megohm, 22pF.
2. Rise Time= 10ns max., Source Impedance= 50 ohms.

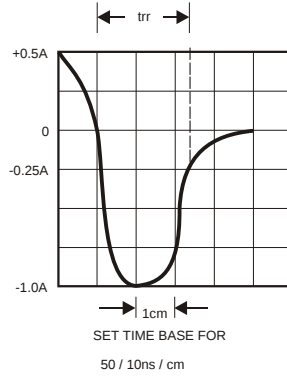


FIG.2-TYPICAL FORWARD CURRENT DERATING CURVE

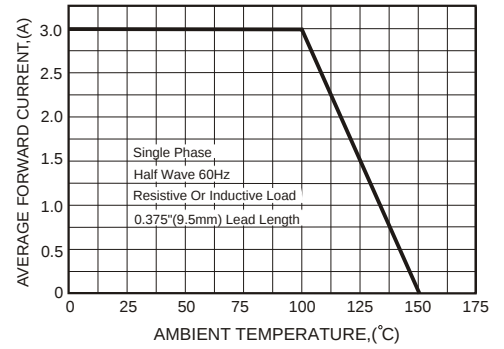


FIG.3-TYPICAL FORWARD CHARACTERISTICS

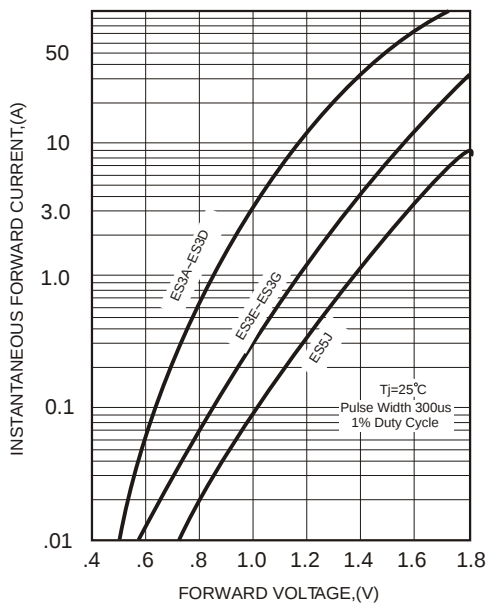


FIG.4-TYPICAL REVERSE CHARACTERISTICS

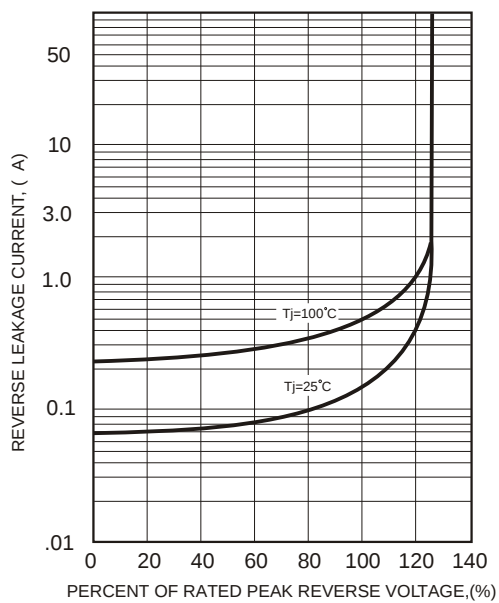


FIG.5-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

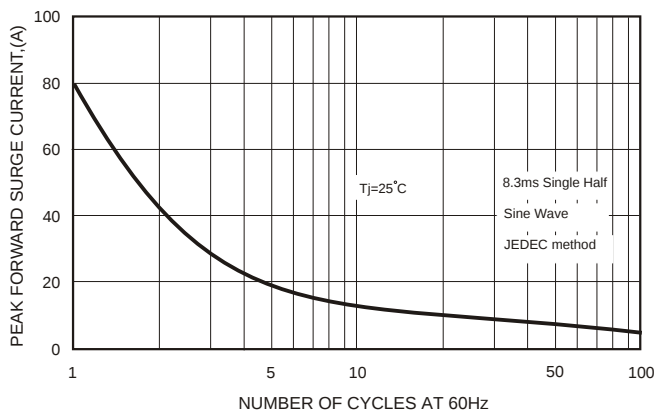
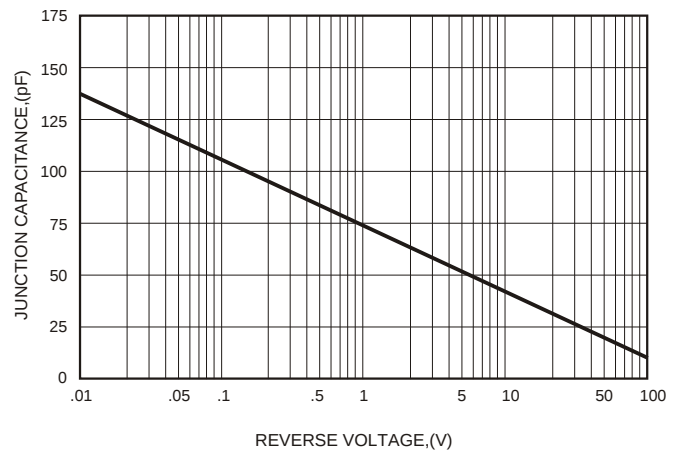


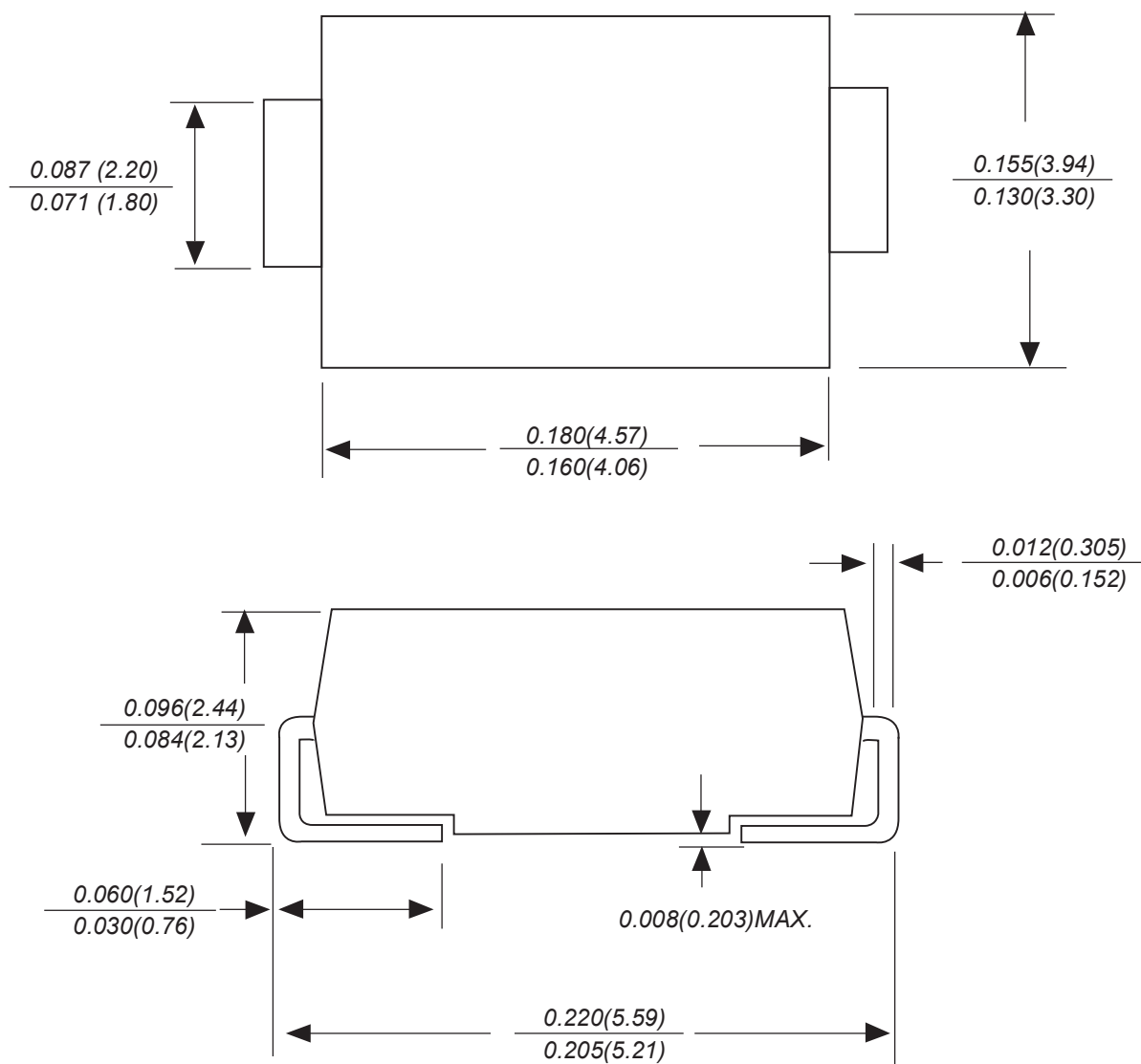
FIG.6-TYPICAL JUNCTION CAPACITANCE





Package Outline Dimensions

SMB



Dimensions in inches and (millimeters)



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